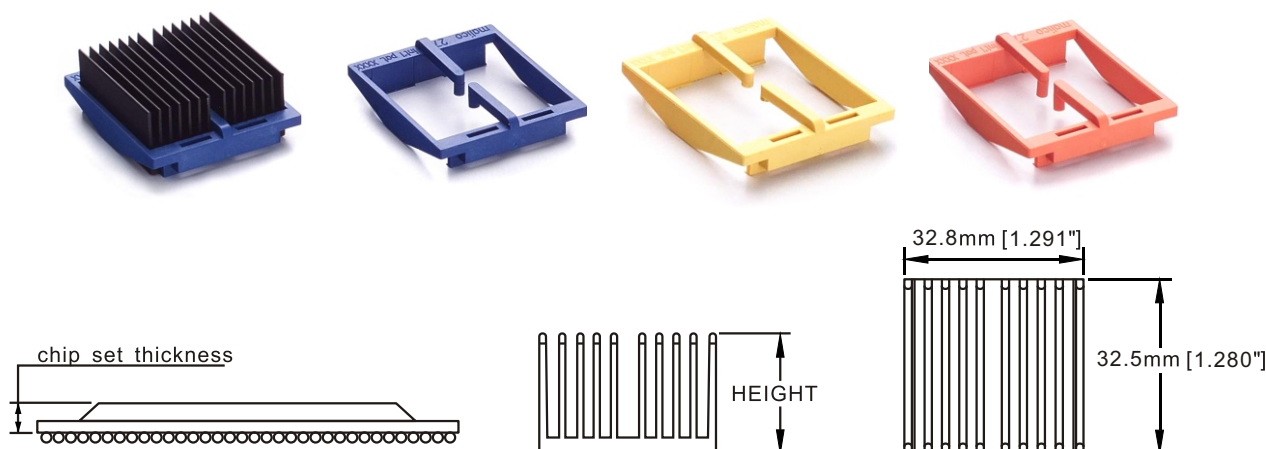


Model : CHBA313333 Series

Specification

BGA Heat Sink for 33x33 chip set



■ Heat sink material :

AL6063

■ Finish :

Black Anodize

■ Chip set package thickness and clip color :

- 2.1mm~2.6mm Yellow clip
- 1.5mm~2.0mm Blue clip
- 0.9mm~1.4mm Orange clip

■ Accessory :

- Clip material Plastic(94V0)
- Thermal pad T725 31x31mm [1.220\"]

Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
CHBA3133330601-00	32.8 [1.291\"]	32.7 [1.287\"]	6.3 [0.248\"]	1.7 [0.066\"]	Yellow
CHBA3133330602-00					Blue
CHBA3133330603-00					Orange
CHBA3133331001-00	32.8 [1.291\"]	32.5 [1.280\"]	9.5 [0.374\"]	1.7 [0.066\"]	Yellow
CHBA3133331002-00					Blue
CHBA3133331003-00					Orange
CHBA3133331301-00	32.8 [1.291\"]	32.5 [1.280\"]	12.7 [0.500\"]	1.7 [0.066\"]	Yellow
CHBA3133331302-00					Blue
CHBA3133331303-00					Orange

Performance

Heat Source(LxW):15x15mm

